NC7NZ04

TinyLogic UHS Inverter

Desription

The NC7NZ04 is a triple inverter from ON Semiconductor's Ultra–High Speed (UHS) series of TinyLogic. The device is fabricated with advanced CMOS technology to achieve ultra–high speed with high output drive while maintaining low static power dissipation over a broad $V_{\rm CC}$ operating range. The device is specified to operate over the 1.65 V to 5.5 V $V_{\rm CC}$ operating range. The inputs and output are high impedance when $V_{\rm CC}$ is 0 V. Inputs tolerate voltages up to 5.5 V, independent of $V_{\rm CC}$ operating voltage.

Features

- Ultra-High Speed: t_{PD} 2.4 ns (Typical) into 50 pF at 5 V V_{CC}
- High Output Drive: ±24 mA at 3 V V_{CC}
- Broad V_{CC} Operating Range: 1.65 V to 5.5 V Power–Down, High–Impedance Inputs / Outputs
- Over-Voltage Tolerance Inputs Facilitate 5 V to 3 V Translation
- Proprietary Noise / EMI Reduction Circuitry
- Space–Saving MicroPak[™] and US8 Surface Mount Packages
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

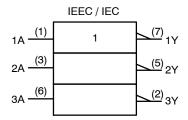


Figure 1. Logic Symbol

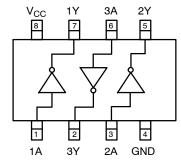


Figure 2. Connection Diagram



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US8 CASE 846AN



MARKING



UQFN8 1.6X1.6, 0.5P CASE 523AY T3&K &2&Z

NZ04, T3 = Specific Device Code

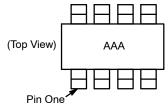
&2 = Date Code

&K = Lot Run Traceability Code \$Y = ON Semiconductor Logo &Z = Assembly Plant Code

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

Pin Configurations



NOTES:

- 1. AAA represents product code top mark (see ordering table).
- Orientation of top mark determines pin one location. Reading the top product code mark left to right, pin one is the lower left pin.

Figure 3. US8

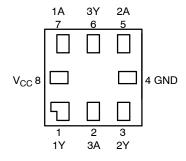


Figure 4. MicroPak (Top Through View)

PIN DEFINITIONS

Pin # US8	Pin # MicroPak	Name	Description
1	7	1A	Input
2	6	3Y	Output
3	5	2A	Input
4	4	GND	Ground
5	3	2Y	Output
6	2	ЗА	Input
7	1	1Y	Output
8	8	V _{CC}	Supply Voltage

FUNCTION TABLE (Y = /A)

Inputs	Output
Α	Y
L	Н
Н	L

ABSOLUTE MAXIMUM RATINGS

Symbol	Param	eter	Min	Max	Unit
V _{CC}	Supply Voltage		-0.5	6.5	V
V _{IN}	DC Input Voltage		-0.5	6.5	V
V _{OUT}	DC Output Voltage		-0.5	6.5	V
I _{IK}	DC Input Diode Current V _{IN} < -0.5 V		=	-50	mA
		V _{IN} > 6.0 V	=	+20	
I _{OK}	DC Output Diode Current	V _{OUT} < -0.5 V	=	-50	mA
		V _{OUT} > 6 V, V _{CC} = GND	=	+20	
I _{OUT}	DC Output Current		=	±50	mA
I _{CC} or I _{GND}	DC V _{CC} or Ground Current		=	±50	mA
T _{STG}	Storage Temperature Range		-65	+150	°C
TJ	Junction Temperature Under Bias	3	=	+150	°C
TL	Junction Lead Temperature (Soldering, 10 Seconds)		=	+260	°C
P_{D}	Power Dissipation at +85°C		=	250	mW
ESD	Human Body Model, JEDEC: JESD22-A114		-	4000	V
	Charge Device Model, JEDEC: J	ESD22-C101	-	2000	1

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

NC7NZ04

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	Supply Voltage Operating		1.65	5.50	V
	Supply Voltage Data Retention		1.5	5.5	
V _{IN}	Input Voltage		0	5.5	V
V _{OUT}	Output Voltage		0	V _{CC}	V
T _A	Operating Temperature		-40	+85	°C
t _r , t _f	Input Rise and Fall Times	V _{CC} at 1.8 V, 2.5 V ±0.2 V	0	20	ns/V
		V _{CC} at 3.3 V ±0.3 V	0	10	
		V _{CC} at 5.0 V ±0.5 V	0	5	
$\theta_{\sf JA}$	Thermal Resistance	US8	-	250	°C/W
		MicroPak	-	287	

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

3. Unused inputs must be held HIGH or LOW. They may not float.

DC ELECTICAL CHARACTERISTICS

				Т	A = 25°	С	$T_A = -40$	to 85°C	
Symbol	Parameter	V _{CC}	Conditions	Min	Тур	Max	Min	Max	Unit
V _{IH}	HIGH Level Input Voltage	1.80 ±0.15		0.65 V _{CC}	_	-	0.65 V _{CC}	-	V
		2.30 to 5.50		0.70 V _{CC}	_	-	0.70 V _{CC}	-	
V _{IL}	LOW Level Input Voltage	1.80 ±0.15		-	_	0.35 V _{CC}	-	0.35 V _{CC}	V
		2.30 to 5.50		-	_	0.30 V _{CC}	-	0.30 V _{CC}	
V _{OH}	HIGH Level Output	1.65 V _{IN} = V _{IL} ,	$V_{IN} = V_{IL}$	1.55	1.65	-	1.55	-	V
	Voltage	2.30	I _{OH} = -100 μA	2.20	2.30	-	2.20	-	
		3.00		2.90	3.00	-	2.90	-	
		4.50		4.40	4.50	-	4.40	-	
		1.65	I _{OH} = -4 mA	1.29	1.52	-	1.29	-	
		2.30	I _{OH} = -8 mA	1.90	2.15	-	1.90	-	
		3.00	I _{OH} = -16 mA	2.40	2.80	-	2.40	-	
		3.00	I _{OH} = -24 mA	2.30	2.68	-	2.30	-	
		4.50	I _{OH} = -32 mA	3.80	4.20	-	3.80	-	
V _{OL}	LOW Level Output	1.65	V _{IN} = V _{IL} ,	-	0.00	0.10	=	0.10	V
	Voltage	2.30	I _{OH} = -100 μA	-	0.00	0.10	=	0.10	
		3.00		-	0.00	0.10	=	0.10	
		4.50		-	0.00	0.10	=	0.10	
		1.65	I _{OH} = 4 mA	-	0.80	0.24	=	0.24	
		2.30	I _{OH} = 8 mA	-	0.10	0.30	=	0.30	
		3.00	I _{OH} = 16 mA	-	0.15	0.40	=	0.40	
		3.00	I _{OH} = 24 mA	-	0.22	0.55	-	0.55	
		4.50	I _{OH} = 32 mA	-	0.22	0.55	=	0.55	
I _{IN}	Input Leakage Current	1.65 to 5.5	0 V _{IN} 5.5 V	-	-	±1	-	±1	μΑ
l _{OFF}	Power-Off Leakage Current	0	V _{IN} or V _{OUT} = 5.5 V	-	-	1	-	10	μΑ
I _{CC}	Quiescent Supply Current	1.65 to 5.50	V _{IN} = 5.5 V, GND	_	_	1	_	10	μΑ

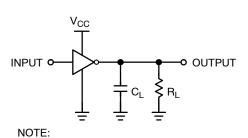
AC ELECTRICAL CHARACTERISTICS

				T _A = 25°C		$T_A = -40$	to 85°C		
Symbol	Parameter	V _{CC}	Conditions	Min	Тур	Max	Min	Max	Unit
t _{PLH} , t _{PHL}		1.80 ±0.15	C _L = 15 pF,	=	4.4	9.5	-	10.0	ns
	(Figure 5, 6)	2.50 ±0.20	$R_L = 1 M\Omega$	=	2.9	5.1	-	5.6	
		3.30 ±0.30		=	2.1	3.4	-	3.8	
		5.00 ±0.50		-	1.8	2.8	-	3.1	
		3.30 ±0.30	C _L = 50 pF,	=	2.9	4.5	-	5.0	
		5.00 ±0.50	$R_L = 500 \Omega$	=	2.4	3.6	-	4.0	
C _{IN}	Input Capacitance	0		-	2.5	-	-	_	pF
C _{PD}	Power Dissipation Capacitance	3.30		-	9	-	-	_	pF
	(Note 4) (Figure 7)	5.00		-	11	-	-	_	

^{4.} C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output lading and operating at 50% duty cycle. C_{PD} is related to I_{CCD} dynamic operating current by the expression:
I_{CCD} = (C_{PD}) (V_{CC}) (f_{IN}) + (I_{CC}static).

DYNAMIC SWITCHING CHARACTERISTICS

				T _A = 25°C	
Symbol	Parameter	Conditions	V _{CC}	Тур	Unit
V _{OLP}	Quiet Output Dynamic Peak V _{OL}	$C_L = 50 \text{ pF}, V_{IH} = 5.0 \text{ V}, V_{IL} = 0 \text{ V}$	5.0	0.8	V
V _{OLV}	Quiet Output Dynamic Valley V _{OL}		5.0	-0.8	V



5. C_L includes load and stray capacitance; inputs PRR = 1.0 MHz, t_W = 500 ns.

Figure 5. AC Test Circuit

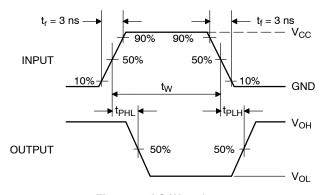
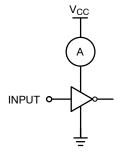


Figure 6. AC Waveforms



NOTE:

6. Input = AC Waveform; $t_r = t_f = 1.8 \text{ ns}$; PRR = 10 MHz; Duty Cycle = 50%.

Figure 7. I_{CCD} Test Circuit

NC7NZ04

DEVICE ORDERING INFORMATION

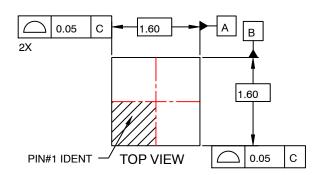
Device	Top Mark	Packages	Shipping [†]
NC7NZ04K8X	NZ04	8-Lead US8, JEDEC MO-187, Variation CA 3.1 mm Wide	3000 / Tape & Reel
NC7NZ04L8X	Т3	8-Lead MicroPak, 1.6 mm Wide	5000 / Tape & Reel

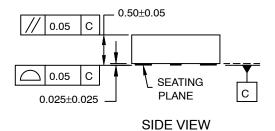
[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

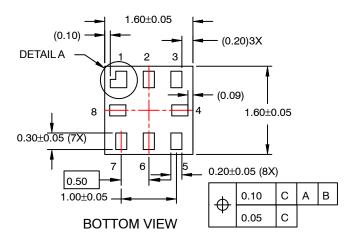
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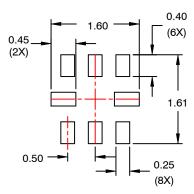
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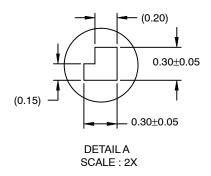




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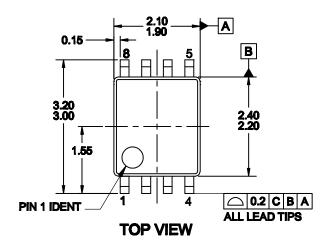


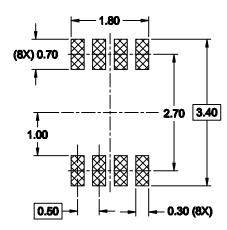
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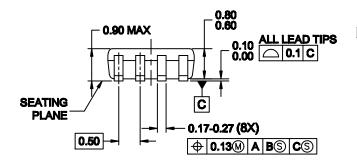
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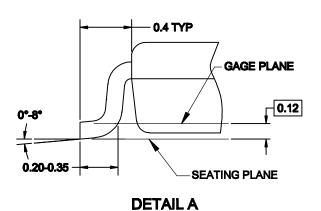
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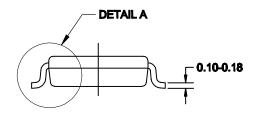


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SIDE VIEW





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